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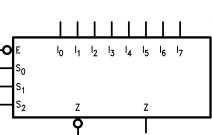
54AC151/54ACT151 8-Input Multiplexer

Check for Samples: 54AC151, 54ACT151

FEATURES

- I_{CC} Reduced by 50% •
- Outputs Source/Sink 24 mA
- 'ACT151 has TTL-Compatible Inputs
- Standard Microcircuit Drawing (SMD)
 - 'AC151: 5962-87691
 - 'ACT151: 5962-88756
- 54AC151 Now Qualified to 300Krad RHA Designation, Refer to the SMD for More Information

Logic Symbols



DESCRIPTION

The 'AC/'ACT151 is a high-speed 8-input digital multiplexer. It provides, in one package, the ability to select one line of data from up to eight sources. The 'AC/'ACT151 can be used as a universal function generator to generate any logic function of four variables. Both true and complementary outputs are provided.

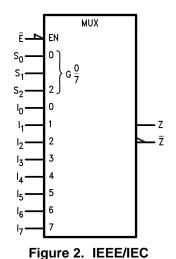


Figure 1.

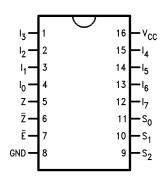
Pin Names	Description
I ₀ -I ₇	Data Inputs
S ₀ -S ₂	Select Inputs
Ē	Enable Input
z	Data Output
Z	Inverted Data Output

A

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Connection Diagrams



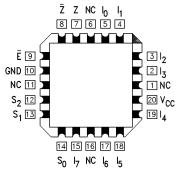


Figure 3. 16-Pin CDIP or CLGA See NFE0016A or NAD0016A Package

Figure 4. 20-Pin LCCC See NAJ0020A Package

Truth Table⁽¹⁾ Inputs Outputs Ε Z S_2 S₁ S₀ Ζ Н Х Н Х Х L \overline{I}_0 L L L L I_0 L L L Н \overline{I}_1 I_1 L \overline{I}_2 L Н L I_2 Ī3 L L Н Н I₃ \overline{I}_4 L Н L L I_4 \overline{I}_5 L Н L Н I_5 L Н Н L \overline{I}_6 I_6 \overline{I}_7 L Н Н Н I_7

(1) H = HIGH Voltage Level L = LOW Voltage Level

X = Immaterial

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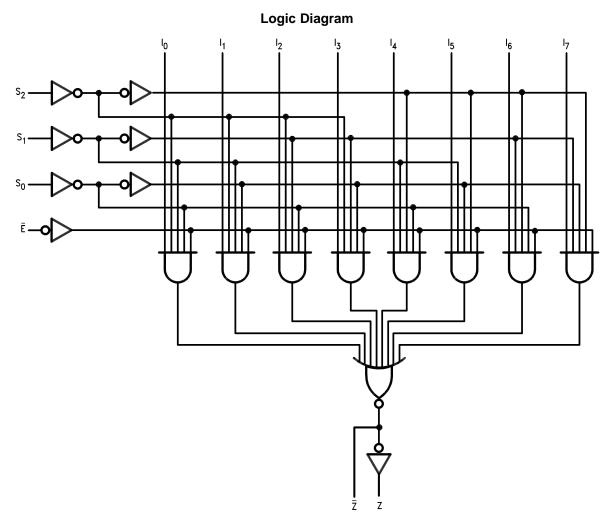
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Functional Description

The 'AC/'ACT151 is a logic implementation of a single pole, 8-position switch with the switch position controlled by the state of three Select inputs, S_0 , S_1 , S_2 . Both true and complementary outputs are provided. The Enable input (\overline{E}) is active LOW. When it is not activated, the complementary output is HIGH and the true output is LOW regardless of all other inputs. The logic function provided at the output is:

 $Z = \overline{E} \bullet (I_0 \bullet \overline{S}_0 \bullet \overline{S}_1 \bullet \overline{S}_2 + I_1 \bullet S_0 \bullet \overline{S}_1 \bullet \overline{S}_2 + I_2 \bullet \overline{S}_0 \bullet S_1 \bullet \overline{S}_2 + I_3 \bullet S_0 \bullet S_1 \bullet \overline{S}_2 + I_4 \bullet \overline{S}_0 \bullet \overline{S}_1 \bullet S_2 + I_5 \bullet S_0 \bullet \overline{S}_1 \bullet \overline{S}_2 + I_6 \bullet \overline{S}_0 \bullet S_1 \bullet S_2 + I_7 \bullet S_0 \bullet S_1 \bullet S_2)$

The 'AC/'ACT151 provides the ability, in one package to select from eight sources of data or control information. By proper manipulation of the inputs, the 'AC/'ACT151 can provide any logic function of four variables and its complement.



Please note that this diagram is provided only for the understanding of logic operations and should not be used to estimate propagation delays.

OBSOLETE

54AC151, 54ACT151



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These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

Absolute Maximum Ratings⁽¹⁾⁽²⁾

Supply Voltage (V _{CC})		-0.5V to +7.0V
	$V_1 = -0.5V$	-20 mA
DC Input Diode Current (I _{IK})	$V_{I} = V_{CC} + 0.5V$	+20 mA
DC Input Voltage (VI)		-0.5V to V _{CC} + 0.5V
DC Output Diada Current (L.)	$V_{O} = -0.5V$	−20 mA
DC Output Diode Current (I _{OK})	$V_{\rm O} = V_{\rm CC} + 0.5 V$	+20 mA
DC Output Voltage (V _O)		-0.5V to V _{CC} + 0.5V
DC Output Source or Sink Current (I _O)		±50 mA
DC V_{CC} or Ground Current per Output Pin (I _{CC}	±50 mA	
Storage Temperature (T _{STG})		−65°C to +150°C
Junction Temperature (T _J)	CDIP	175°C

(1) Absolute Maximum Ratings are those values beyond which damage to the device may occur. The databook specifications should be met, without exception, to ensure that the system design is reliable over its power supply, temperature, and output/input loading variables. TI does not recommend operation of FACT[®] circuits outside databook specifications.

(2) If Military/Aerospace specified devices are required, please contact the Texas Instruments Sales Office/Distributors for availability and specifications.

Recommended Operating Conditions

Supply Voltage (V)	'AC	2.0V to 6.0V
Supply Voltage (V _{CC})	'ACT	4.5V to 5.5V
Input Voltage (V _I)		0V to V _{CC}
Output Voltage (V _O)		0V to V _{CC}
Operating Temperature (T _A)	54AC/ACT	−55°C to +125°C
	V_{IN} from 30% to 70% of V_{CC}	125
Minimum Input Edge Rate (ΔV/Δt) 'AC Devices	V _{CC} @ 3.3V, 4.5V, 5.5V	125 mV/ns
	V _{IN} from 0.8V to 2.0V	
Minimum Input Edge Rate ($\Delta V/\Delta t$) 'ACT Devices	V _{CC} @ 4.5V, 5.5V	125 mV/ns

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DC Characteristics for 'AC Family Devices

	Parameter		54AC		Conditions
Symbol		V _{CC} (V)	T _A = −55°C to +125°C	Units	
			Ensured Limits		
V _{IH}	Minimum High Level Input Voltage	3.0	2.1		V _{OUT} = 0.1V
		4.5	3.15	V	or V_{CC} – 0.1V
		5.5	3.85		
V _{IL}	Maximum Low Level Input Voltage	3.0	0.9		$V_{OUT} = 0.1V$
		4.5	1.35	V	or V_{CC} – 0.1V
		5.5	1.65		
V _{OH}	Minimum High Level Output Voltage	3.0	2.9		I _{OUT} = -50 μA
		4.5	4.4	V	
		5.5	5.4		
					$V_{IN} = V_{IL} \text{ or } V_{IH}^{(1)}$
		3.0	2.4		I _{OH} = −12 mA
		4.5	3.7	V	I _{OH} = −24 mA
		5.5	4.7		I _{OH} = −24 mA
V _{OL}	Maximum Low Level Output Voltage	3.0	0.1		I _{OUT} = 50 μA
		4.5	0.1	V	
		5.5	0.1		
					$V_{IN} = V_{IL} \text{ or } V_{IH}^{(1)}$
		3.0	0.50		$I_{OL} = 12 \text{ mA}$
		4.5	0.50	V	I _{OL} = 24 mA
		5.5	0.50		I _{OL} = 24 mA
I _{IN}	Maximum Input Leakage Current	5.5	±1.0	μA	$V_{I} = V_{CC}, GND$
I _{OLD}	Minimum Dynamic Output	5.5	50	mA	V _{OLD} = 1.65V Max
I _{OHD}	Current ⁽²⁾	5.5	-50	mA	V _{OHD} = 3.85V Min
I _{CC}	Maximum Quiescent Supply Current	5.5	80.0	μA	V _{IN} = V _{CC}
					or GND

(1) All outputs loaded; thresholds on input associated with output under test.

(2) Maximum test duration 2.0 ms, one output loaded at a time.

EXAS STRUMENTS

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DC Characteristics for 'ACT Family Devices

			54ACT		
Symbol	Parameter	V _{cc} (V)	T _A = −55°C to +125°C	Units	Conditions
			Ensured Limits		
V _{IH}	Minimum High Level Input	4.5	2.0	V	V _{OUT} = 0.1V
	Voltage	5.5	2.0		or V _{CC} – 0.1V
V _{IL}	Maximum Low Level Input	4.5	0.8	V	V _{OUT} = 0.1V
	Voltage	5.5	0.8		or V _{CC} – 0.1V
V _{OH}	Minimum High Level Output	4.5	4.4	V	I _{OUT} = −50 μA
	Voltage	5.5	5.4		
					$V_{IN} = V_{IL} \text{ or } V_{IH}^{(1)}$
		4.5	3.70	V	I _{OH} = −24 mA
		5.5	4.70		I _{OH} = −24 mA
V _{OL}	Maximum Low Level Output	4.5	0.1	V	Ι _{ΟUT} = 50 μΑ
	Voltage	5.5	0.1		
					$V_{IN} = V_{IL} \text{ or } V_{IH}^{(1)}$
		4.5	0.50	V	I _{OL} = 24 mA
		5.5	0.50		I _{OL} = 24 mA
I _{IN}	Maximum Input Leakage Current	5.5	±1.0	μΑ	$V_{I} = V_{CC}, \text{ GND}$
I _{CCT}	Maximum I _{CC} /Input	5.5	1.6	mA	$V_{I} = V_{CC} - 2.1V$
I _{OLD}	Minimum Dynamic Output	5.5	50	mA	V _{OLD} = 1.65V Max
I _{OHD}	Current ⁽²⁾	5.5	-50	mA	V _{OHD} = 3.85V Min
I _{CC}	Maximum Quiescent Supply Current	5.5	80.0	μΑ	V _{IN} = V _{CC} or GND

All outputs loaded; thresholds on input associated with output under test.
Maximum test duration 2.0 ms, one output loaded at a time.

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AC Electrical Characteristics

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	Parameter		54	54AC		Fig.
Symbol		V _{CC} (V) ⁽¹⁾	T _A = −55°C to +125°C		Units	
-			C _L =	50 pF		No.
			Min	Max		
t _{PLH}	Propagation Delay	3.3	1.0	22.0	ns	
	S_n to Z or \overline{Z}	5.0	1.0	15.5		
t _{PHL}	Propagation Delay	3.3	1.0	22.0	ns	
	S_n to Z or \overline{Z}	5.0	1.0	15.5		
t _{PLH}	Propagation Delay	3.3	1.0	15.5	ns	
	\overline{E} to Z or \overline{Z}	5.0	1.0	12.0		
t _{PHL}	Propagation Delay	3.3	1.0	15.5	ns	
	\overline{E} to Z or \overline{Z}	5.0	1.0	12.0		
t _{PLH}	Propagation Delay	3.3	1.0	16.0	ns	
	I_n to Z or \overline{Z}	5.0	1.0	12.0		
t _{PHL}	Propagation Delay	3.3	1.0	18.0	ns	
	I_n to Z or \overline{Z}	5.0	1.0	13.0		

(1) Voltage Range 3.3 is 3.3V ±0.3V. Voltage Range 5.0 is 5.0V ±0.5V.

TEXAS INSTRUMENTS

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AC Electrical Characteristics

			54	ACT		
Symbol	Parameter	V _{CC} (V) ⁽¹⁾	T _A = −55°C to +125°C		Units	Fig.
Symbol	Parameter		C _L =	50 pF	Units	No.
			Min	Max		
t _{PLH}	Propagation Delay	5.0	1.0	19.5	ns	
	S _n to Z					
t _{PHL}	Propagation Delay	5.0	1.0	20.0	ns	
	S _n to Z					
t _{PLH}	Propagation Delay	5.0	1.0	19.5	ns	
	S_n to \overline{Z}					
t _{PHL}	Propagation Delay	5.0	1.0	20.0	ns	
	S_n to \overline{Z}					
t _{PLH}	Propagation Delay	5.0	1.0	12.0	ns	
	E to Z					
t _{PHL}	Propagation Delay	5.0	1.0	12.5	ns	
	E to Z					
t _{PLH}	Propagation Delay	5.0	1.0	12.0	ns	
	\overline{E} to \overline{Z}					
t _{PHL}	Propagation Delay	5.0	1.0	12.5	ns	
	\overline{E} to \overline{Z}					
t _{PLH}	Propagation Delay	5.0	1.0	15.0	ns	
	I _n to Z					
t _{PHL}	Propagation Delay	5.0	1.0	16.0	ns	
	I _n to Z					
t _{PLH}	Propagation Delay	5.0	1.0	15.0	ns	
	I_n to \overline{Z}					
t _{PHL}	Propagation Delay	5.0	1.0	16.0	ns	
	I_n to \overline{Z}					

(1) Voltage Range 5.0 is $5.0V \pm 0.5V$.

Capacitance

Symbol	Parameter	Тур	Units	Conditions
C _{IN}	Input Capacitance	4.5	pF	$V_{CC} = OPEN$
C _{PD}	Power Dissipation Capacitance	70.0	pF	$V_{CC} = 5.0 V$

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Changes from	Revision		nril 2013)	to	Revision	C
changes nom	Revision	D (A)	טווו בטוס)	ιο	Revision	C

Changed layout of	National Data Sheet to TI format	8
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